

IC3DIT 2019

The International Conference on 3D Imaging Technology

Kunming, Yunnan, China

August 15-18, 2019

Organization Committee:

General Chair

Prof. Dr. Srikanta Patnaik
Prof. Dr. Junsheng Shi
Prof. Dr. Roumen Kountchev

Organising Chair

Dr. Yonghang Tai

International Advisory Chair:

Dr. Roumiana Kountcheva

Technical Program Committee

Prof. Vladicescu Popentiu, Florin, City University, UK
Prof. Guangzhi Qu, Oakland University, USA
Prof. Dr. Zhengtao Yu, Kunming University of Science and Technology
Prof. V.S.S. Yadavalli, University of Pretoria, South Africa
Prof. Bruno Apolloni, Università degli Studi di Milano, Italy
Prof. Harry Bouwman, Delft University of Technology, Netherlands
Prof. Shyi-Ming Chen, National Taiwan University of Science and Technology, Taiwan
Prof. Yahaya Coulibaly, University Technology Malaysia, Malaysia
Prof. Ing Kong, RMIT University, Australia
Prof. Gerald Midgley, Centre for Systems Studies, Business School, University of Hull, UK
Prof. Khubaib Ahmed, Hamdard University, Pakistan
Prof. Moustafa Mohammed Eissa, Faculty of Engineering-Helwan University, Egypt
Dr. Fernando Boronat Seguí, Universitat Politècnica de Valencia, Spain
Dr. Mohamed Atef, Assiut University, Egypt

PAPER SUBMISSION

Authors are invited to submit full papers (4 to 6 pages in PDF format. Please download the template from conference website and submit full paper at www.s3dconference.com

Selected excellent 30 papers will be recommended for publication in EI, SCI Journal.

Contact Us

Phone: +86-18271938662

Tel: +86-027-87153536

QQ: 1707285880

Email: ic3dit@163.com

Organizing Chair: yonghang@deakin.edu.au

The annual International Conference on 3D Imaging Technology will be held during August 15-18 in Kunming, China. The aim of the conference is to provide a platform for Academicians, Researchers, Scientists and Professionals to share their knowledge and expertise in the field of 3D Imaging Technology.

IC3DIT2019 will be published by **Springer Book Series--Smart Innovation, Systems and Technologies (SIST)**, and it will be submitted to ISI Proceedings, EI-Compendex, SCOPUS, Google Scholar and Springerlink for indexing.

Smart Innovation, Systems and Technologies (SIST) is in EI Compendex List. Currently, the retrieval of papers which are submitted by IEEE-CPS is normal.

Selected papers will be published in an extended form in one of the following EI or SCI journals:

- (1) Enterprise Information Systems (Indexed: SCI/EI/Scopus/Inspec)
- (2) International Journal of Computational Intelligence Systems (Indexed: SCI/EI/Scopus/Inspec)
- (3) International Journal of Information and Communication Technology (Indexed: EI/Scopus/Inspec)
- (4) International Journal of Information Systems and Supply Chain Management (Indexed: EI/Scopus/Web of Science ESCI/Inspec)
- (5) International Journal of Information Systems in the Service Sector (Indexed: EI/Scopus/Web of Science ESCI/Inspec)
- (6) International Journal of Grid and Utility Computing (Indexed: EI/Scopus/Inspec)
- (7) International Journal of Applied Decision Sciences (Indexed: EI/Scopus/Inspec)
- (8) International Journal of Enterprise Information Systems (Indexed: EI/Scopus/Web of Science ESCI/Inspec)
- (9) International Journal of Communication Networks and Distributed Systems (Indexed: EI/Scopus/Inspec)
- (10) International Journal of Management and Decision Making (Indexed: Scopus/Google Scholar)
- (11) International Journal of Knowledge Engineering and Data Mining (Indexed: Inspec/Google Scholar)
- (12) International Journal of Strategic Decision Sciences (Indexed: Inspec/Google Scholar)

Topics which are included, but are not limited to, are the following:

3D Image Transformation, 3D Tensor Image Representation, 3D Image Transformation, 3D Content Generation Technologies, 3D Printing Technology, Naked 3D Display, Dynamic 3D Display, Auxiliary 3D Display, VR/AR/MR Device, 3D Deep Learning, 3D Computer Vision, 3D Graphics Algorithm, 3D Image Graphics Applications, 3D Video Communications, 3D Medical Image Processing and Analysis, 3D Remote Sensing Images and Systems, 3D Animation and Industrial Applications, Advanced 3D Computing Systems, 3D Data-Storage Technology...

IMPORTANT DATES:

Conference Date: 2019.8.15-8.18

Submission Due: 2019.7.5

ORGANIZERS:

Yunnan Normal University

SIKSHA 'O' ANUSANDHAN

IRNet International Academic Communication Center



IRNet 国际学术交流中心
International Academic Communication Center

SIKSHA 'O' ANUSANDHAN

Committee Chair Members and Guests



Prof. Dr. Srikanta Patnaik

Department of Computer Science and Engineering, Faculty of Engineering and Technology, SOA University, Bhubaneswar Odisha, India



Prof. Dr. Junsheng Shi

School of Physics and Electronic Information, Yunnan Normal University



Prof. Dr. Roumen Kountchev

School of Faculty of Telecommunications, Department of Radio Communications and Video Technologies at the Technical



Dr. Yonghang Tai

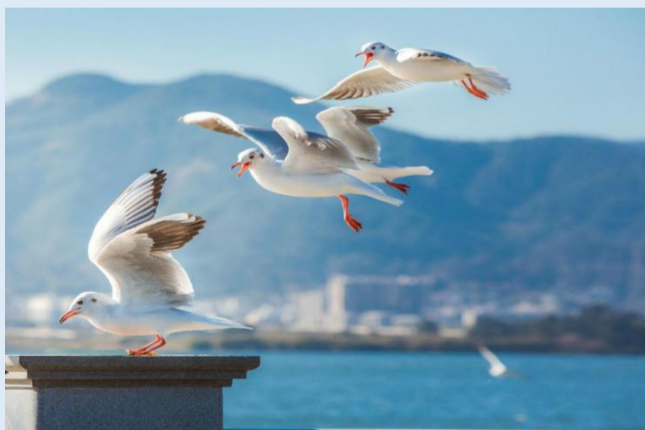
Color & Image Vision Lab., Yunnan Normal University, Kunming, China



Dr. Roumiana Kountcheva

Vice president of TK Engineering, Sofia

About Kunming, China



Kunming enjoys the reputation of “Spring City”, the capital of Yunnan Province, China's gateway city to Southeast Asia and South Asia, and a national historical and cultural city. It is an important tourist and commercial city in China and one of the important central cities in the western region.

Kunming is located in the middle part of the Yunnan-Guizhou Plateau, connected to the Liang-Shan Yi Nationality in the north, Yuxi City in the southwest, and the Honghe Hani and Yi Autonomous Prefecture in the south. It borders the Chuxiong Yi Autonomous Prefecture in the west and Qujing City in the east. It is the core circle of the Yunnan City Group, the center of the Asian 5-hour aviation circle and one of the national first-class logistics park layout cities. Kunming is a mountainous landform. The terrain is generally high in the north and low in the south, with multiple caves and lava fields, and the lava basin has a stone forest dam. It enjoys the north subtropical low latitude plateau mountain monsoon climate. The climate in Kunming is pleasant with annual average temperature 16.5 °C, average annual rainfall 1450 mm, the frost-free period 278 days.

Kunming is open and fashionable, concentrating the geographical advantages of Yunnan. From the “Southern Silk Route” more than 2000 years ago to the open Kunming, it has been a land hub for economic and trade exchanges and political ties between the East Asian continent, Indo-China Peninsula and the the South Asian Sub-Continent countries. “China Kunming Import and Export Fair”, “China International Tourism Trade Fair” and “China Kunming International Tourism Festival” make Kunming one of the major exhibition cities in China.

